

LSV 2 ONBOARD DATA ACQUISITION SYSTEM (ODAS)

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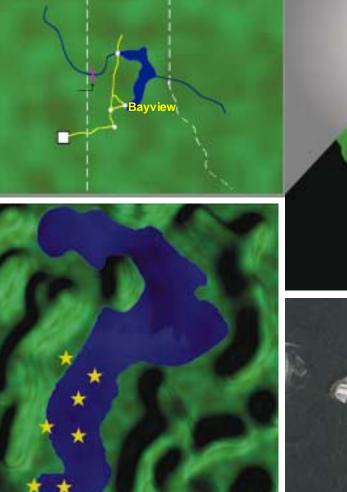
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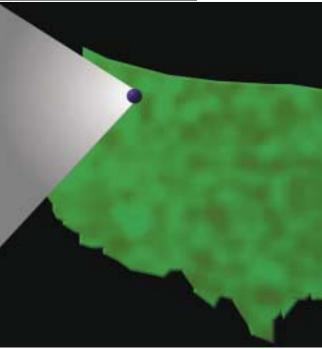


Acoustic Research Detachment -Bayview, Idaho



- □ 1000' deep, quiet lake
- Technologies supported include:
 - Advanced submarine
 propulsor designs
 - Submarine sonar dome designs
 - Structural acoustics
 - Target strength
 - Hull treatments
 - Active noise control
 - Wide aperture arrays
 - Towed arrays









Large Scale Vehicle (LSV) KOKANEE

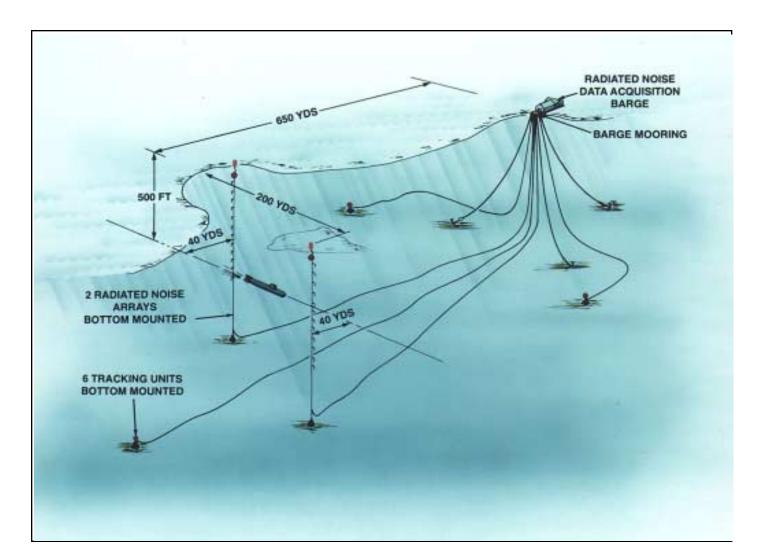






LSV Radiated Noise Range









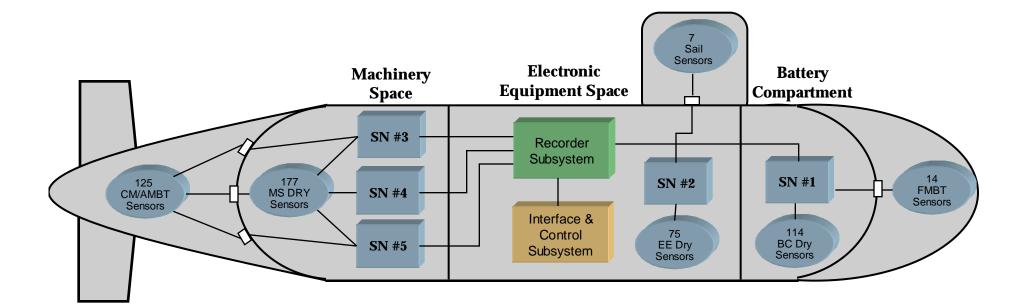


- Autonomous hydro-dynamic and acoustic data recording system onboard Large Scale Vehicle 2 -CUTTHROAT
 - 512 channel analog sensor inputs, analog signal conditioning, A-to-D conversion at variable sample rates up to Fs = 196.6 KS/sec
 - 80 MB/sec data rate over Asynchronous Transfer Mode (ATM) sensor network (at delivery)
 - 80+ MB/sec record rate via COTS Fibre Channel RAID system

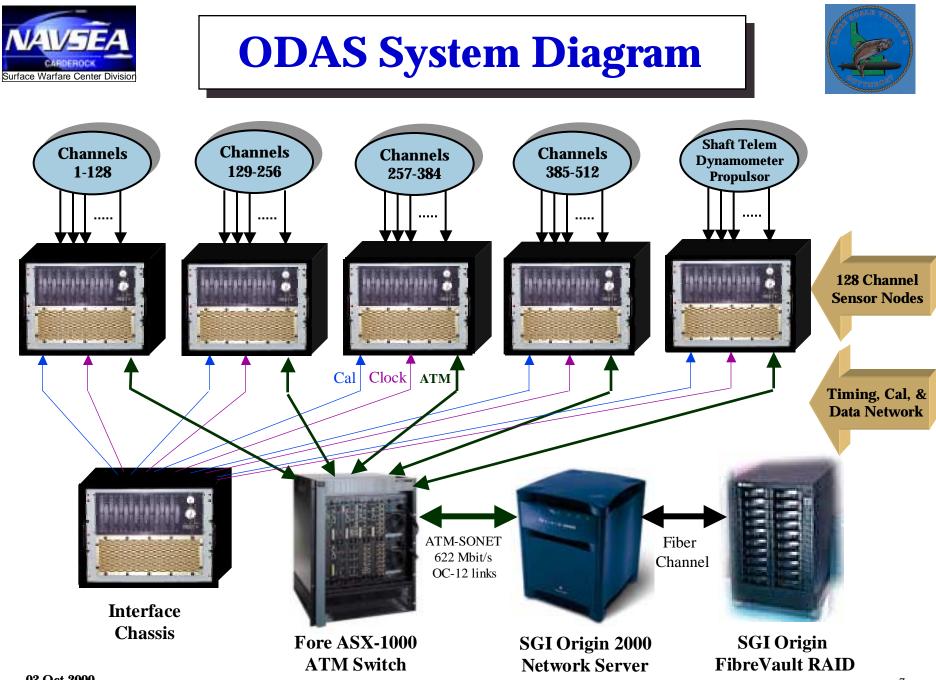


ODAS System Laydown





- Sensor Network Subsystem
 - **Recorder Subsystem**
- Interface & Control Subsystem







- Leverage recent advances in high-speed computers and interfaces for instrumentation recording
- Modular design permits easy expansion throughout system
 - System expandable to 1536 channels
 - 300 MB/sec. bandwidth
- COTS and Open Architecture maximizes supportability by on-site personnel
 - Single Vendor Configuration Management
 - Single SW Development Environment





□ Lowest Risk:

- Network Server eliminated potential board-level integration
 problems
 - » Server is a pre-integrated high-speed data handling system with hardware and software support from single vendor
- System elements communicate through standard vendor supported interfaces
 - » ATM, Fibre Channel, Ethernet

□ Lowest Cost:

- Identical development and target systems reduce software cost
 - » Standard development environment
 - » Short test cycle
- Server eliminates component integration costs
- Upgrades can utilize future hardware advances



Sensor Network



□ Multi-function Signal Conditioning on 6U VME Board

- 16 channels/board
- Power & calibration distribution to various acoustic & hydrodynamic sensors (CVLD, CCLD, & differential or single ended)
- Gain & Filtering (12 x 5 dB, pre-whitening & anti-alias)

□ Analog-to-ATM Conversion on Single 6U VME Board

- Planning Systems, Inc. AtA-16b-32AD-V1
- 32 channels/board, OC-3c output
- 5 operator selected sample rates per channel, Max. Fs = 196,608 Sample/sec
- Converts analog inputs to digital ATM AAL5 Protocol Data Units (PDU's)
- 53 Byte cells optically telemetered via OC-3c SONET to ATM switch
- □ ATM Switch
 - Fore Systems ASX-1000
 - Switches OC-3c inputs from Analog-to-ATM boards to Recorder subsystem via OC-12c network modules



Recorder Subsystem



COTS Recording Hardware

- Network Server (SGI Origin 2000)
- Fiber Channel RAID (SGI Origin FibreVault RAID)

Standards Based High-Speed Interfaces

- Asynchronous Transfer Mode (ATM) OC-3c, OC-12c SONET
- Dual Fibre Channel arbitrated loop
- 100baseTx & 1000baseTx Ethernet

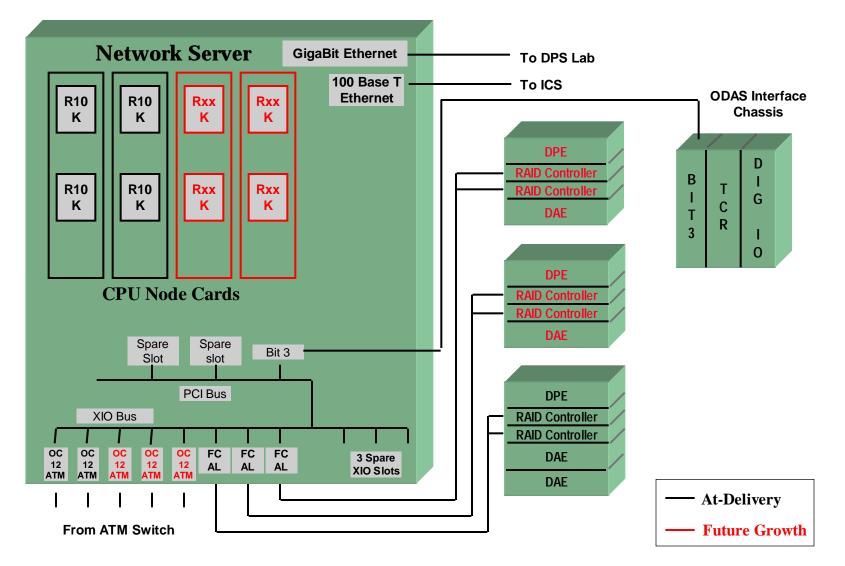
COTS Data Archival/System Backup Hardware

• Dual DLT 7000 drives



Recorder Block Diagram









Rack Mountable Origin 2000 Network Server

- System at Delivery (80 Mbytes/sec)
 - » 4 R10K processors (2 per node card)
 - » 2 XIO OC-12 ATM card
 - » 1 XIO Dual-AL Fiber Channel Card
 - » 1 PCI card for IRIG Time
- Full System (300 Mbytes/sec)
 - » 8 processors (4 R10K + 4 R??K)
 - » 6 XIO 4-port OC-3 or 2 XIO OC-48 ATM card
 - » 3 XIO Dual-AL Fiber Channel cards
 - » 1 PCI card for IRIG Time
 - » 2.56 GB/sec sustained system bus throughput







Silicon Graphics Fiber Channel RAID System

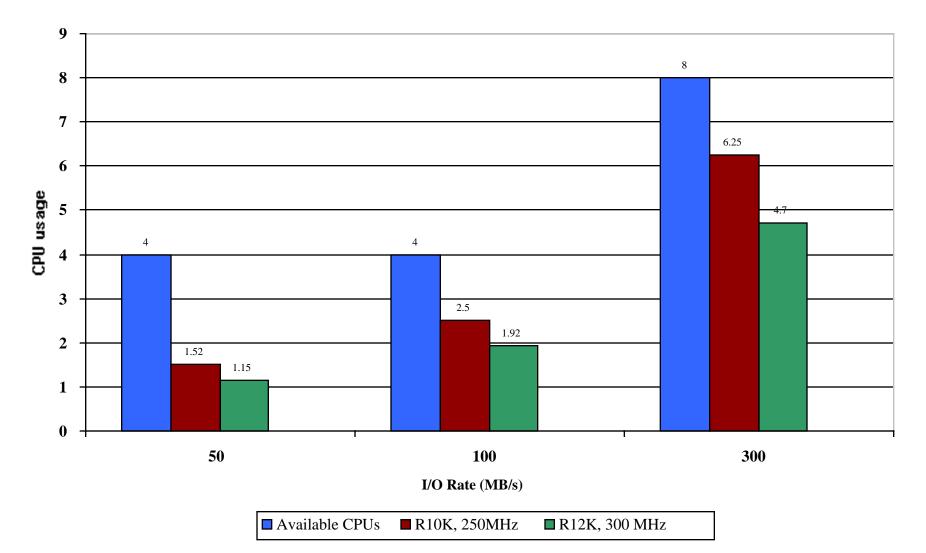
- RAID Level 3 implementation
- Dual Arbitrated Loop interface with server
- System at delivery (80 MBytes/sec)
 - » 1 Disk Processor Enclosure (DPE)
 - » 2 Disk Array Enclosures (DAE)
 - » 2 RAID Controllers (in the DPE)
 - » 100+ MB/sec throughput, 432 GB capacity
- Full-Up System (300 MBytes/sec)
 - » 3 Disk Processor Enclosures (DPE)
 - » 4 Disk Array Enclosures (DAE)
 - » 6 RAID Controllers (in the DPE's)
 - » 300 MB/sec. throughput, 2.0 TB+ capacity





CPU Utilization







RAID Throughput



